

W81386D



W81386D
Winbond USB Interface
MS/SD/MMC Reader



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1. GENERAL DESCRIPTION

The W81386D is a high-integrated USB1.1 full-speed MS/SD/MMC reader controller. W81386D is an USB full-speed device, which can provide up to 12Mb/s data transfer rate. W81386D meets USB bus-powered device spec with embedded 5V-3.3V power regulator, external power adopter is no needed, and USB plug and play feature provides nice user experience. W81386D is a single chip solution with 48-pin LQFP streamline package, which can be easily integrated into PC, NB, or external peripheral device to implement MS/SD/MMC reader function.

2. FEATURES

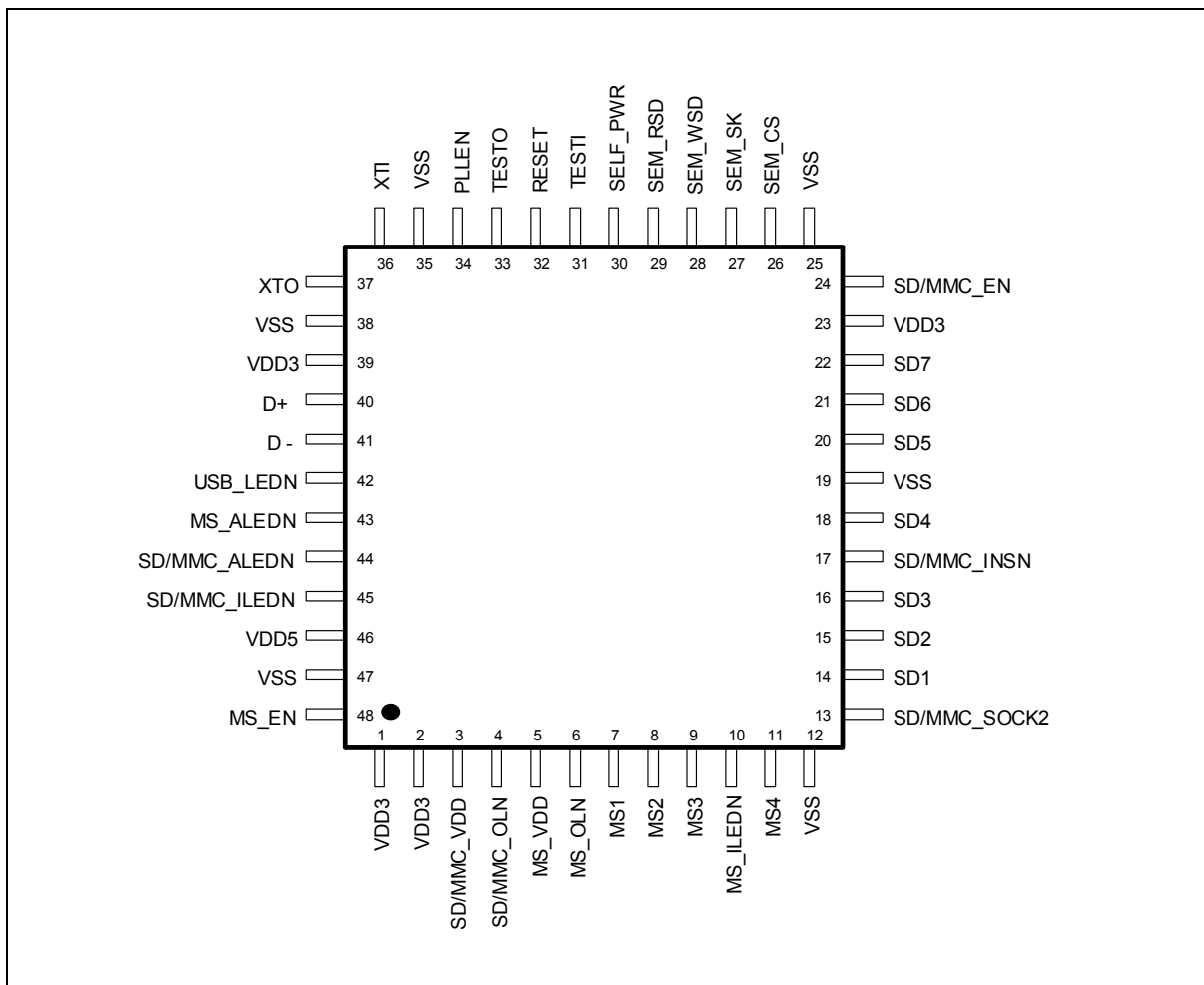
- High integrated single chip solution
- Compliant with USB Specification Version 1.1
- Compliant with MS (Memory Stick™) Specification Version 1.3
- Compliant with SD (Secure Digital) Specification Version 1.0
- Compliant with MMC Specification Version 2.2
- USB bus-powered device compliant
- 6MHz clock input to eliminate EMI effect
- Optional serial EEPROM interface for vendor ID and product ID download
- USB full speed device with 12Mb/s transmitting rate
- Support suspend and resume function
- Remote wake up supported
- Two or three LED mode supported, to indicate power on, card insert, and data access with hardware setting selection
- Power saving mode supported
- Built-in 5V to 3.3V regulator
- Implement over current detection circuit for abnormal card insertion protection
- 48 pin LQFP package

Ordering Information

PART NUMBER	PACKAGE TYPE	PRODUCTION FLOW
W81386D	48-PIN LQFP	Commercial, 0°C to +70°C
W81386-DG	48-PIN LQFP (Pb-free)	Commercial, 0°C to +70°C



3. PIN CONFIGURATION





4. PIN DESCRIPTIONS

PIN	NAME	TYPE ^{*1}	DESCRIPTION
MS Interface:			
7	MS1	DO	Memory Stick connection pin #1
8	MS2	SDO/SDI	Memory Stick connection pin #2
9	MS3	DI	Memory Stick connection pin #3
11	MS4	DO	Memory Stick connection pin #4
5	MS_VDD	DO	Power output signal for Memory Stick card.
48	MS_EN	DI	Memory Stick enable pin ^{*2} . The description is at Note 2.
6	MS_OLN	SDI	Schmitt trigger input pin, used to detect the signal of over-loading from external over-current detect component. This pin is active low.
SD/MMC Interface:			
14	SD1	SDO/SDI	SD connection pin#1
15	SD2	SDO/SDI	SD connection pin#2
16	SD3	DO/DI	SD connection pin#3
18	SD4	DO	SD connection pin#4
20	SD5	SDO/SDI	SD connection pin#5
21	SD6	SDO/SDI	SD connection pin#6
22	SD7	DI	SD connection pin#7
3	SD/ MMC_VDD	DO	Power output signal for SD/ MMC memory card.
24	SD/ MMC_EN	DI	SD/MMC enable pin ^{*2} . The description is at Note 2.
4	SD/ MMC_OLN	SDI	Schmitt trigger input pin, used to detect the signal of over-loading from external over-current detect component. This pin is active low.
13	SD/MMC_SOCK2	DI	SD/MMC socket mode setting. When use Socket1 ^{*3} , set this pin to 0 -- connect to GND. When use Socket2 ^{*3} , set this pin to 1 -- connect to VDD3.
17	SD/MMC_INSN	DI	SD/MMC card insert detection. Need external pull-up resistor to VDD3. And if use Socket2 ^{*3} , connect to card-detect pin of the socket.



PIN DESCRIPTIONS, continued

PIN	NAME	TYPE ^{*1}	DESCRIPTION
USB Interface:			
40	D+	AIO	USB D plus signal.
41	D-	AIO	USB D minus signal.
Crystal Driver:			
6	XTI	DI	Clock driver input signal for 6MHz crystal, may be used as the external clock 48MHz(oscillator) input.
37	XTO	DO	Clock driver output signal.
34	PLLEN	DI	Internal PLL enable. When use 6MHz, set this pin to 0 -- connect to GND. When use 48MHz, set this pin to 1 -- connect to VDD3.
Serial EEPROM Interface:			
26	SEM_CS	DI/DO	DO: Serial EEPROM chip select. DI: Connect to VDD3 for default VID/PID setting.
27	SEM_SK	DO/DI	Serial EEPROM Serial Clock. The setting pin of LED indicate mode in default setting.
28	SEM_WSD	DO/DI	Serial EEPROM command Write Serial Data. The setting pin of LED indicate mode in default setting.
29	SEM_RSD	SDI	Serial EEPROM Read Serial Data. Remote wake up set pin in default setting
LED indicator:			
42	USB_LEDN	DO	LED indicator for USB port. (active low)
43	MS_ALEDN	DO	LED indicator for MS card accessing (active low)
10	MS_ILEDN	DO	LED indicator for MS card insert.(active low)
45	SD/MMC_ILEDN	DO	LED indicator for SD/ MMC card insert. (active low)
44	SD/ MMC_ALEDN	DO	LED indicator for SD/ MMC card accessing. (active low)
Other Signal:			
32	RESET	SDI	Reset input, hardware reset input, active high.
30	SELF_PWR	DI	If it is high, SELF_PWR configured, pull low.
31	TESTI	DI	Test Input, must left open when in normal operation.
33	TESTO	DO	Test output, must float in normal operation.



PIN DESCRIPTIONS, continued

PIN	NAME	TYPE*1	DESCRIPTION
Power:			
46	VDD5	PI	Power 5V.
1, 2, 23, 39	VDD3	PO	Embedded regulator power 3.3V output, need to connect a 10uF capacitor. This pin should not provide power to external components or circuit.
12, 19, 25, 35, 38, 47	VSS	G	Ground.

Note 1: Type: AI is Analog Input, AO is Analog Output, DI is Digital Input, DO is Digital Output, PI is Power Input, PO is Power Output, G is Ground and S is Schmitt trigger.

Note 2: MS_EN and SD/MMC_EN are mode enable pins.

MS_EN	SD/MMC_EN	DESCRIPTION
Low	High	Enable Memory Stick only.
High	Low	Enable SD/MMC only.
Low	Low	Enable both Memory Stick and SD/MMC. And LED indicator mode is individual mode. (Sec. 7.2)
High	High	Enable both Memory Stick and SD/MMC. And LED indicator mode is sharing mode. (Sec. 7.2)

Note 3: Socket1 means a SD/MMC card socket, which is without additional card detect switch.

Socket2 means a SD/MMC card socket, which is with additional card detect switch.



5. BLOCK DIAGRAM

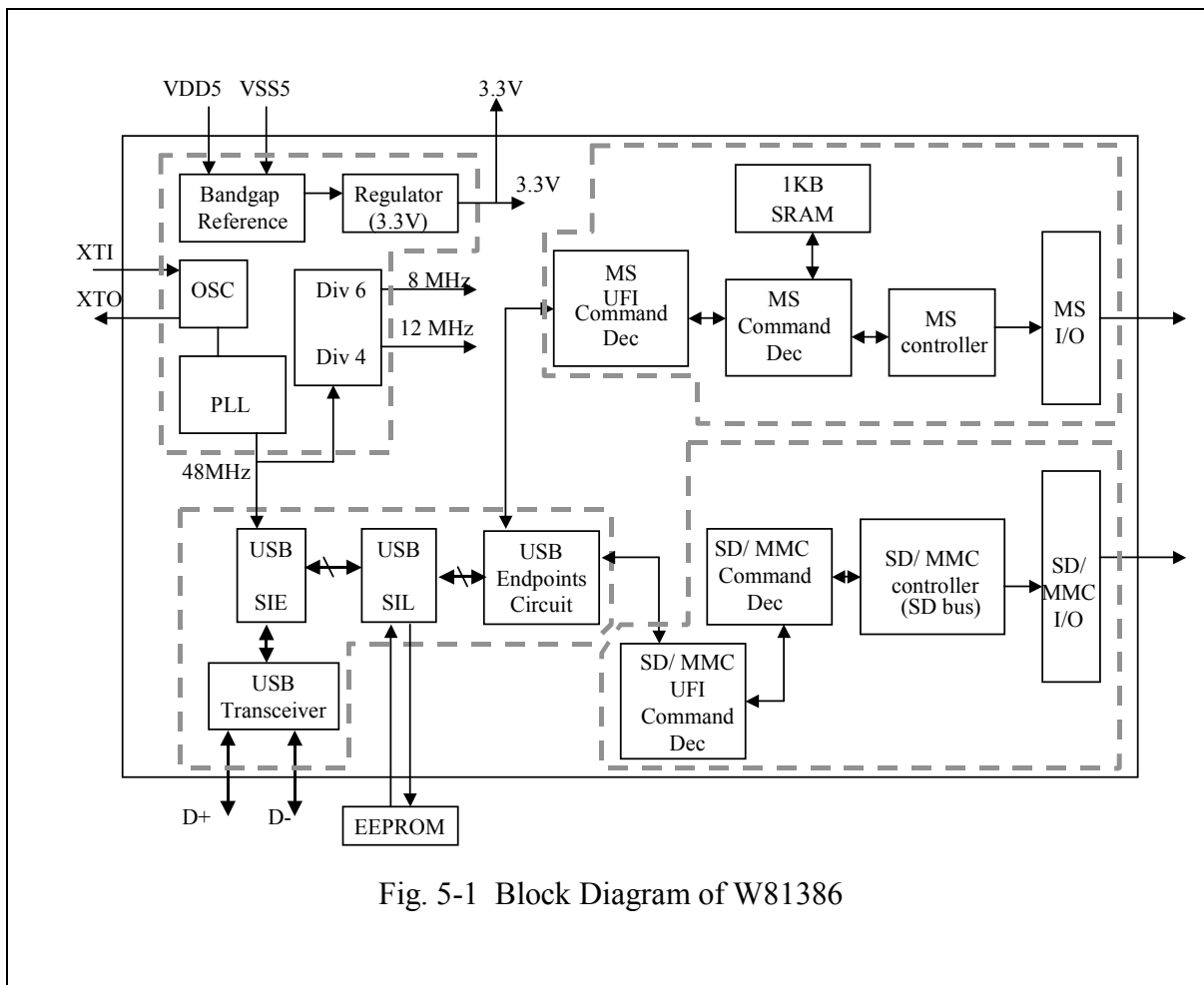


Fig. 5-1 Block Diagram of W81386



6. USB INTERFACE CIRCUIT

USB interface circuit includes USB transceiver, USB serial interface engine (SIE), USB transaction control logic, USB endpoint control logic and endpoint circuit. The USB transaction control logic and USB endpoint control logic also called USB serial interface logic (SIL). Figure 6-1 shows the detail block diagram of USB interface circuit.

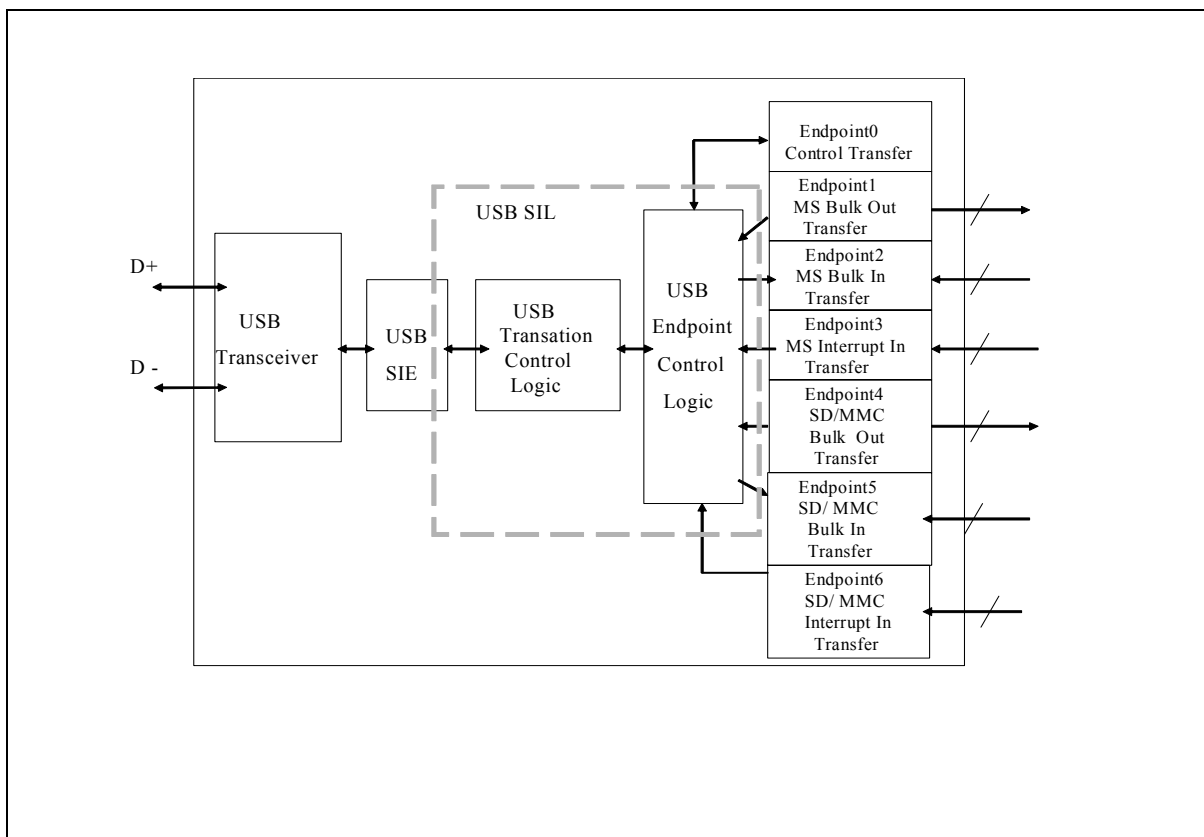


Fig6-1 Block Diagram of USB Interface Circuit



7. SERIAL EEPROM INTERFACE DESCRIPTION AND MODE SETTING

The serial EEPROM (93C46) is optional for some of parameter setting. If SEM_CS = high(short to VDD3) is used to set the default parameter mode (like default USB VID/PID). And the LED indicator mode set at SEM_SK and SEM_WSD pins. If the pin SEM_CS is Open and the serial EEPROM is existent, the parameters should load from the serial EEPROM.

7.1 The Data Format of Serial EEPROM

If the parameter is read from serial EEPROM, the LED indicator mode is set in one byte data stored in the EEPROM.

Data record in 93C46 for setting:

- Only one set of VID, PID, power setting, string descriptor, and LED setting in the 93C46.

ADDRESS*	CONTENT	DESCRIPTION
0	iVender / Device Desc, Low-byte.	Vender ID.
1	iVender / Device Desc, High-byte.	Vender ID.
2	iProduct / Device Desc, Low-byte.	Product ID.
3	iProduct / Device Desc, High-byte.	Product ID.
4	bcdDevice / Device Desc, Low-byte.	Device releaseNo. in bcd code.
5	bcdDevice / Device Desc, High-byte.	Device releaseNo. in bcd code.
6	bmAttribute / Configuration Desc.	Bit7: Reserved and must set 1. Bit6: Self Powered. Bit5: Remote wake up enable. Bit[4:0]: Reserved.
7	MaxPower / Configuration Desc.	Maximum Power consumption = $n \times 2 \text{ mA}$.
8	USB iProduct and LED setting.	Bit [2:1] is the same state setting of SEM_SK and SEM_WSD when default setting during reset. Bit 7 = 1 is enable USB iProduct string. Bit 7 = 0 is disable USB iProduct string.
9	LED flash period setting.	Fine tune the access LED flash periods, the maximum value is about 1 Hz.
10	String length.(must set less than or equal to 48)	String length of USB iProduct string,the maximum string length is 46 characters
11	0x00	Must be 0x00.
12	0x03.	Must 0x03 value.



Continued.

ADDRESS*	CONTENT	DESCRIPTION
13~57	String content.	Each character use two bytes, 45 characters at most in the string. One byte of data 00 between each character should not write in the 93C46, the data 00 may be filled in the unused content if the number of characters is less than 45.
58~65	Reserve	Reserve
66~81	UFI response data (Product Identification).	16 bytes Product Identification of UFI inquiry data, independent of MS interface or SD/MMC interface. The order should be reverse

7.2 LED Indicator and Mode Setting (when SEM_CS = High)

The LED driver outputs are all active low, and use 5V VDD for the LED power. It should avoid the internal regulator to drive LEDs.

USB_LEDN, MS_ALEDN and SD/MMC_ALEDN can be use in two LED indicate mode or three LED indicate mode. If SEM_CS short to VDD3 is used to set the default parameter mode, the LED indicate mode also set at SEM_SK and SEM_WSD pins during reset. SEM_SK = Low (open) is 3_LED mode, SEM_SK = High(short to VDD3) is 2_LED mode. The SEM_WSD is effective in 3_LED mode, ALED will not flash when SEM_WSD = Low (open) ALED will flash when SEM_WSD = High (short to VDD3).

Mode setting table:

SEM_CS	SEM_SK	SEM_WSD	SEM_RSD	FUNCTION
1	0	0	X	Default VID/PID and string descriptor, 3_LED and ALED no flash.
1	0	1	X	Default VID/PID and string descriptor, 3_LED and ALED flash.
1	1	X	X	Default VID/PID and string descriptor, 2_LED and ALED flash.
1	X	X	0	Default VID/PID and string descriptor, remote wake up enable.
1	X	X	1	Default VID/PID and string descriptor, remote wake up disable.

* 1 is short to VDD3 and 0 is open on the board for SEM_CS, SEM_SK, SEM_WSD. 0 for SEM_RSD must be connected to GND.

**LED light state table:**

STATE →	POWER DOWN	USB ACTIVITY	CARD INSERTING		CARD ACCESSING		
			3_LED	2_LED	3_LED	3_LED/flash	2_LED
USB_LEDN	Off	On	On	On	On	On	On
MS_ILEDN, SD/MMC_ILEDN	Off	Off	On	Off	On	On	Off
MS_ALEDN, SD/MMC_ALEDN	Off	Off	Off	On	On	Flash	Flash

LED indicator setting:

When MS_EN and SD_EN can be selected by user (MS and SD/MMC for the customer), the MS_EN and SD/MMC_EN also can be select the LED driver:

- MS_EN = high, SD/MMC_EN = low: MS disable and SD/MMC enable, MS_ALED off always.
- MS_EN = low, SD/MMC_EN = high: MS enable and SD/MMC disable, SD/MMC_ILED and SD/MMC_ALED off always.
- MS_EN = low, SD/MMC_EN = low: both MS enable and SD/MMC enable, MS_ILED for MS card insert, MS_ALED is for MS accessing, SD/MMC_ILED and SD/MMC_ALED are for SD/MMC card insert and accessing.
- MS_EN = high, SD/MMC_EN = high: both MS enable and SD/MMC enable, the MS card insert or SD/MMC card insert will reflect on the SD/MMC_ILED status, the MS accessing or SD/MMC accessing will reflect on the SD/MMC_ALED.

8. ELECTRICAL CHARACTERISTICS**8.1 Maximum Ratings***

	PARAMETER	SYMBOL	RATING	UNITS
1	Supply Voltage with respect to V_{AVSS}	V_{VDD5}	-0.3 to 6	V
2	Supply Voltage with respect to V_{VSS}	V_{VDD3}	-0.3 to 6	V
3	Current at any pin other than supplies		0 to 10	mA
4	Storage Temperature	T_{st}	-65 to 150	°C

*Exceeding these values may cause permanent damage



8.2 Recommended Operating Conditions

	CHARACTERISTICS	SYMBOL	RATING	UNIT
1	Operation Voltage (referenced to AVSS pin).	V_{VDD5}	4.0 to 5.5	V
2	Operation Voltage (referenced to VSS pin).	V_{VDD3}	3.6 to 3.6	V
5	Clock Frequency at XT1 pin	f_{XTL}	6 or 48	MHz
6	Clock Frequency Tolerance	Δf_C	325 or 2500	PPM
7	Operation Temperature	T_{op}	0 to 70	°C

8.3 Power Supply Characteristics

	PARAMETER	CONDITION	SYMBOL	MIN	TYP‡	MAX	UNITS	NOTES
1	Standby Supply Current	Power Supply	I_Q		378	500	uA	1
2	Operating Supply Current				34		mA	2

‡: Typical figure are at $V_{VDD5} = 5.0V$ and temperature = 25 °C and are for design aid only, not guaranteed and not subject to production testing.

Note1: All input pins are V_{VDD} or V_{VSS} , configured as power down mode, output without loading and no clock input on the XT1 pins.

Note2: 6MHz external clock input on the XT1 pin, output without loading. For two interface, and access two cards at the same time.

8.4 Digital Characteristics

	PARAMETER	CONDITION	SYMBOL	MIN	TYP‡	MAX	UNITS	NOTES
1	Output High Voltage	2mA load	V_{OH}	0.9			VDD3	1
2	Output Low Voltage	2mA load	V_{OL}			0.1	VDD3	1
3	Output High Voltage at CLK output	2mA load		0.9			VDD3	
4	Output Los Voltage at CLK output	2mA load				0.1	VDD3	
5	High Level Input Voltage		V_{IH}	0.7			VDD3	



Digital Characteristics, continued.

	PARAMETER	CONDITION	SYMBOL	MIN	TYP‡	MAX	UNITS	NOTES
6	Low Level Input Voltage		V_{IL}			0.3	VDD3	
7	Input Current		I_{in}			1	μA	
8	Input Capacitance		C_{in}		10		pF	

‡: Typical figure are at $V_{DD3} = 3.3V$ and temperature = 25 °C and are for design aid only, not guaranteed and not subject to production testing.

Note1: All input pins except CLK output.

8.5 Timing Characteristics

	PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTE
1	XTI	fXTI	6 or 48			MHz	1
2	XTI duty cycle		40%	-	60%	1 clock	
3	XTO delay time	fXTO _d	-	-	5	ns	
MS Serial Interface Signals referenced to MSCLK(figure 8-1)							
1	BS output delay	tBSd		3	5	ns	
2	SDIO output delay time	tSDIOd		5	8	ns	
3	SDIO input setup time	tSDIOSu	10			ns	
4	SDIO input hold time	tSDIOh	5			ns	
SD/MMC Serial Interface Signals referenced to SDCLK(figure 8-2)							
1	Input CMD, DAT setup time	tCMDsu tDATsu	5			ns	
2	Input CMD, DAT hold time	tCMDh tDATh	5			ns	
3	Output CMD Delay time	tCMDd		7	14	ns	
4	Output DAT Delay time	tDATd		4	14	ns	

Note1: external clock input.

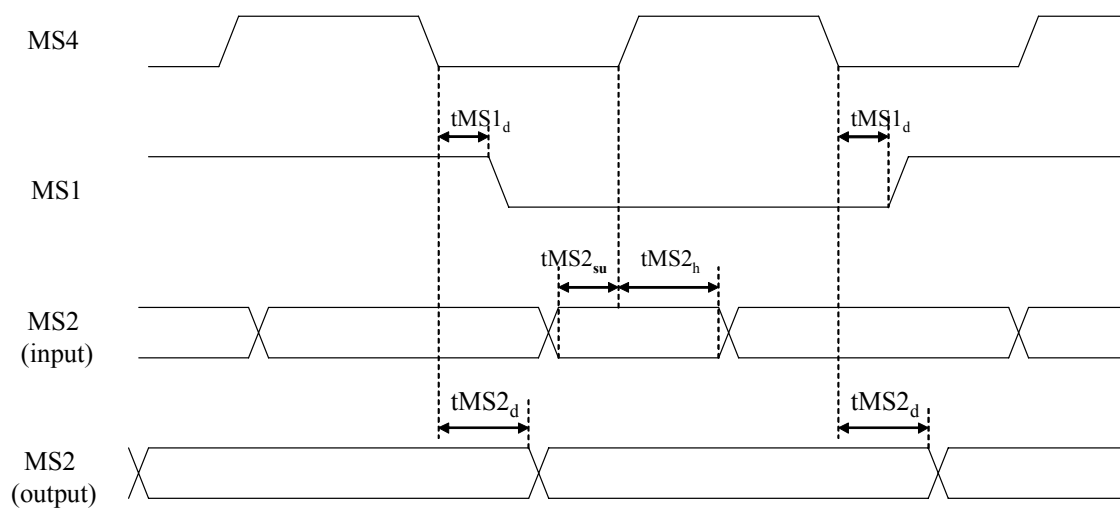
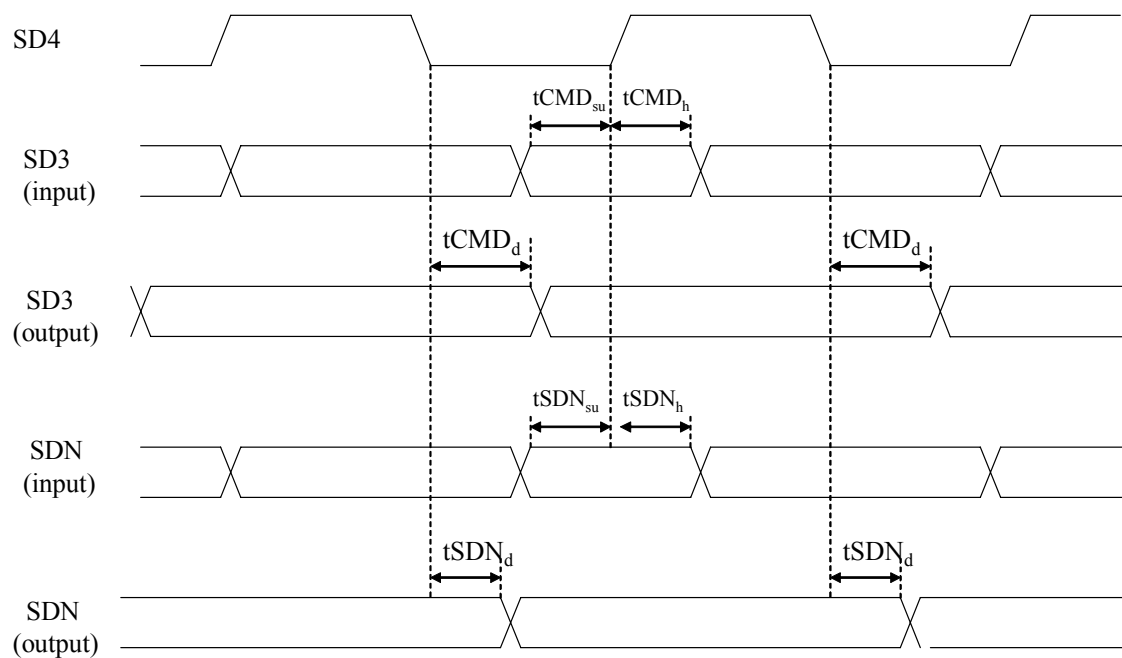


Fig.8-1 MS Serial Interface Signals referenced to MS4



SDN: SD1, SD2, SD5, SD6

Fig. 8-2 SD/MMC Serial Interface Signals referenced to SD4

W81386D



9. HOW TO READ THE TOP MARKING

The top marking of W81386D



1st line: Winbond logo

2nd line: Part number of W81386D

3rd line: Tracking code 118 G A 01A SA

118: packages made in '01, week 18

G: assembly house ID; A means ASE, O means OSE, G means GR

A: IC revision; A means version A, B means version B

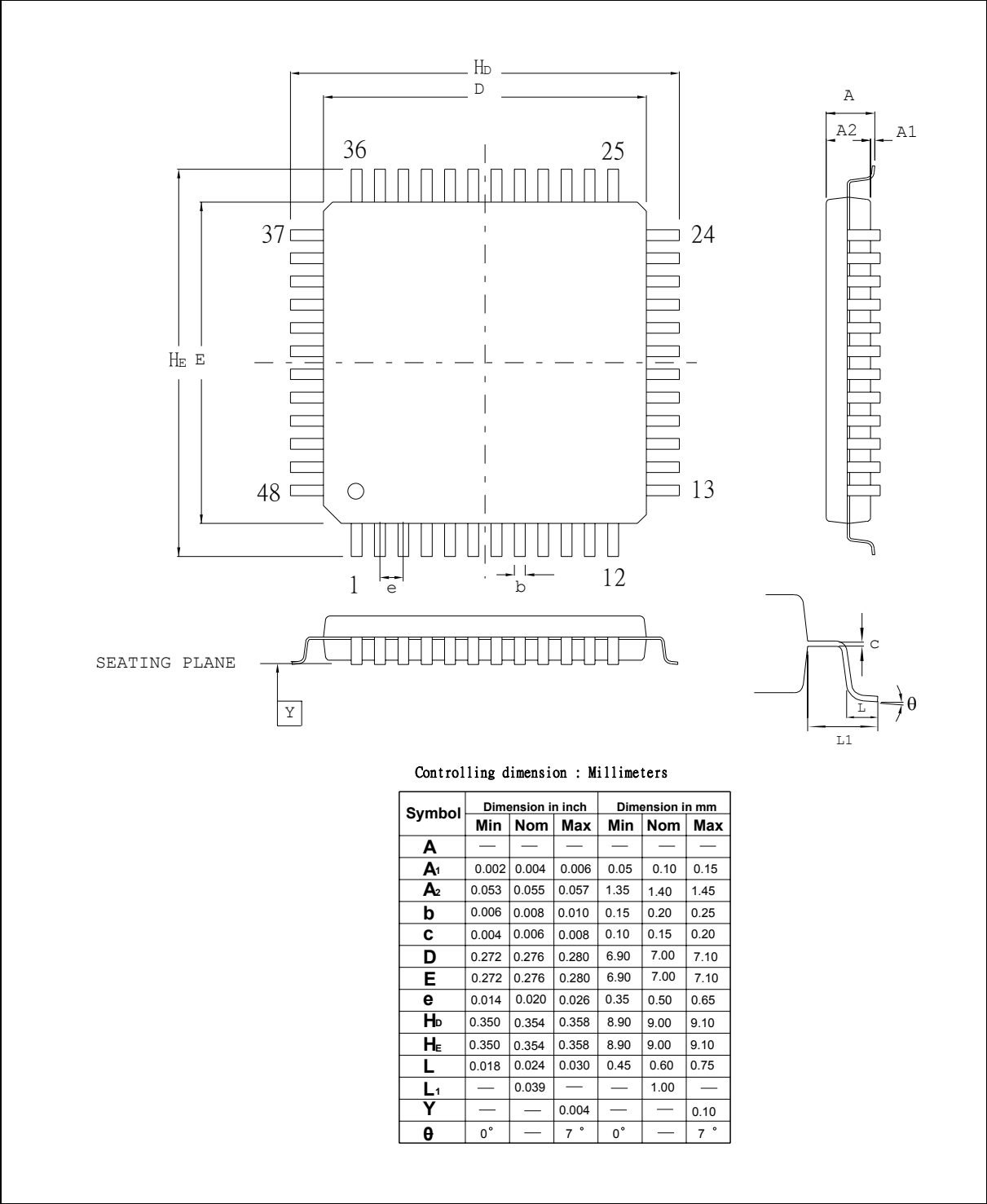
01A: for internal use

SA: for internal use



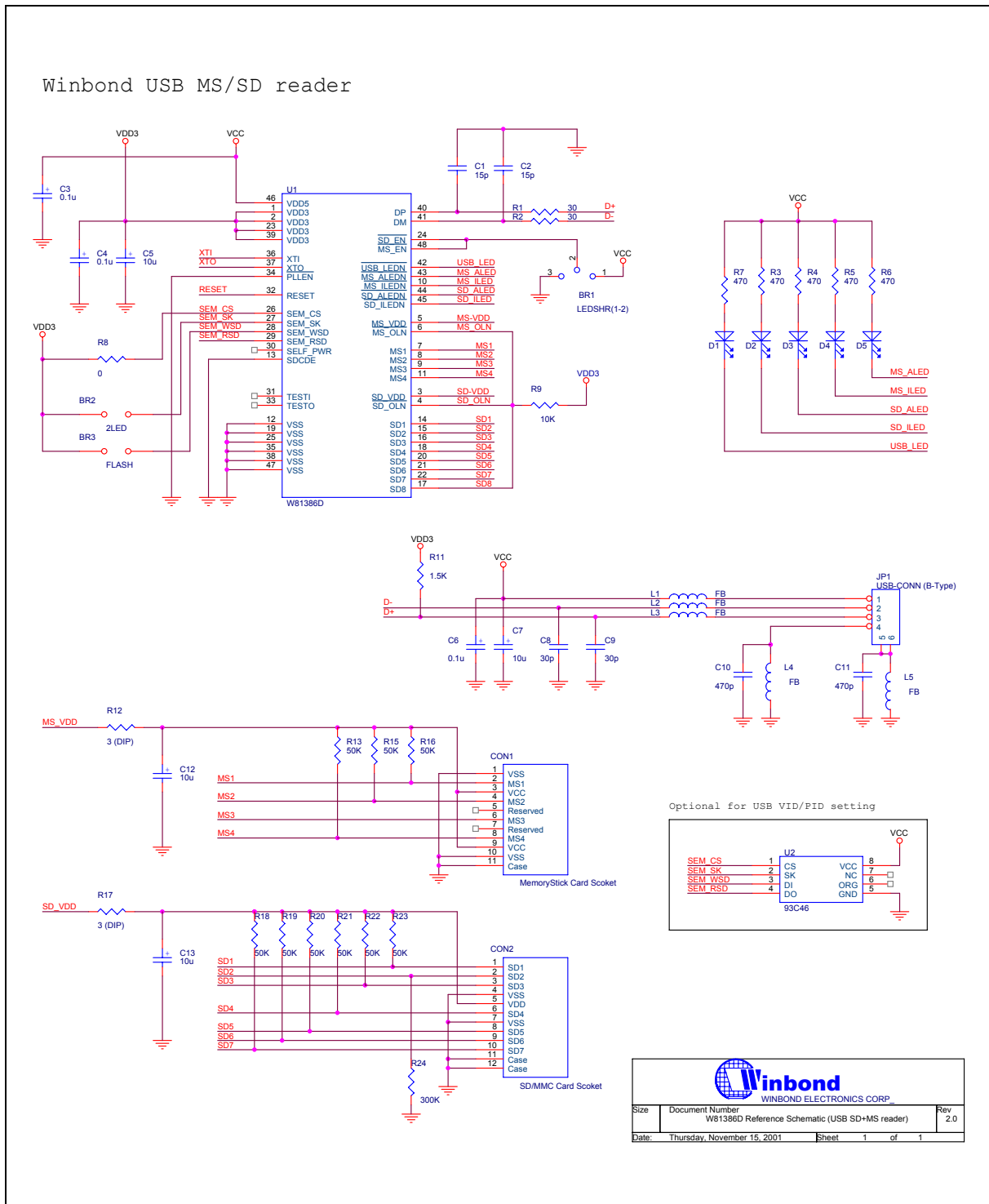
10. PACKAGE DIMENSIONS

48-LQFP(7x7x1.4mm footprint 2.0mm)



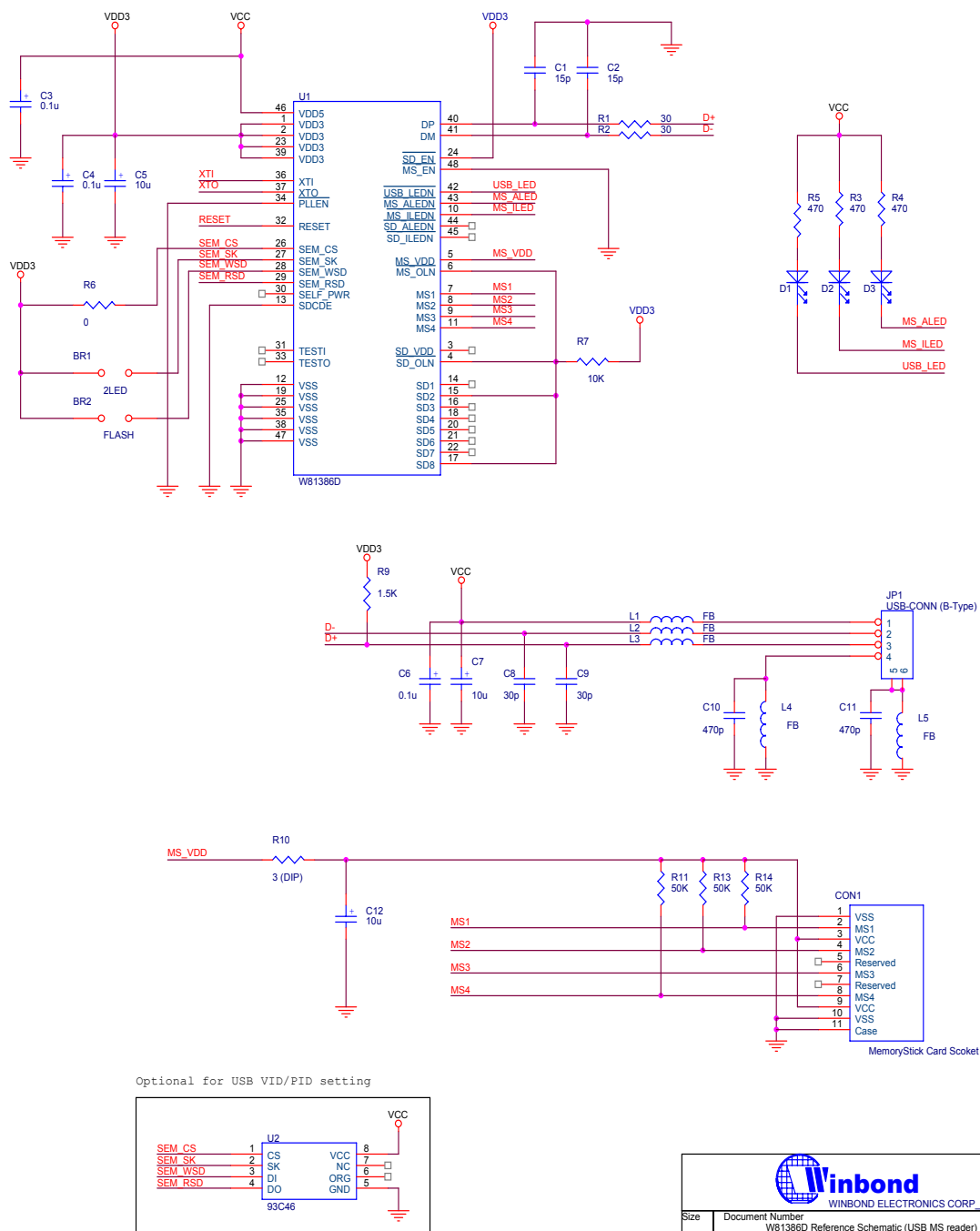


11. REFERENCE SCHEMATIC





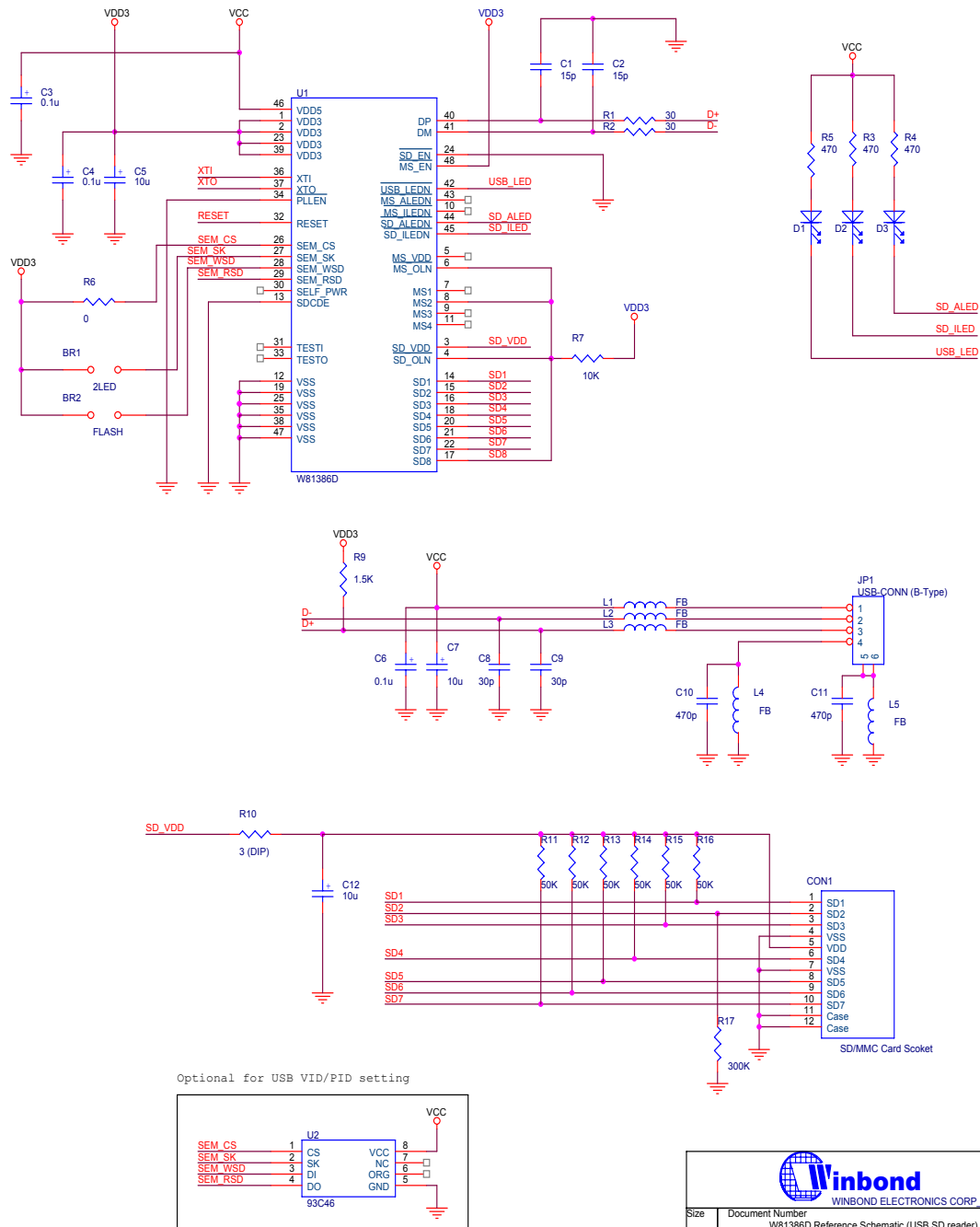
Winbond USB MS reader



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Size	Document Number	Rev
	W81386D Reference Schematic (USB MS reader)	2.0
Date:	Thursday, November 15, 2001	Sheet 1 of 1



Winbond USB SD reader



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Size	Document Number	Rev
	W81386D Reference Schematic (USB SD reader)	2.0
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12. REVISION HISTORY

VERSION	DATE	PAGE	DESCRIPTION
0.50	07/2001		First published.
0.6	05/2004		Add Pb-Free Package
A1	May 26, 2005	22	ADD Important Notice

Important Notice

Winbond products are not designed, intended, authorized or warranted for use as components in systems or equipment intended for surgical implantation, atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, or for other applications intended to support or sustain life. Further more, Winbond products are not intended for applications wherein failure of Winbond products could result or lead to a situation wherein personal injury, death or severe property or environmental damage could occur.

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